



N-Channel Super Junction Power MOSFET II

General Description

The series of devices use advanced super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

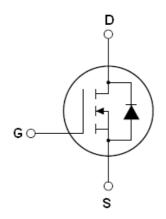
Features

- New technology for high voltage device
- ●Low on-resistance and low conduction losses
- ●Small package
- Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

V _{DS} @T _{jmax}	710	V
R _{DS(ON)} TYP	2.2	Ω
I_{D}	2	A



Schematic diagram

Package Marking And Ordering Information

Device	Device Package	Marking
NCE65R2K2I	TO-251	NCE65R2K2I
NCE65R2K2K	TO-252	NCE65R2K2K





TO-251

TO-252

Table 1. Absolute Maximum Ratings (T_c=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (V _{GS} =0V)	V _{DS}	650	V
Gate-Source Voltage (VDS=0V)	V _{GS}	±30	V
Continuous Drain Current at Tc=25°C	I _{D (DC)}	2	А
Continuous Drain Current at Tc=100°C	I _{D (DC)}	1.3	Α
Pulsed drain current (Note 1)	I _{DM (pluse)}	6	А
Maximum Power Dissipation(Tc=25℃)	P_{D}	23	W
Derate above 25°C		0.184	w/°C
Single pulse avalanche energy (Note2)	Eas	45	mJ
Avalanche current ^(Note 1)	I _{AR}	1	А
Repetitive Avalanche energy , t_{AR} limited by T_{jmax} (Note 1)	E _{AR}	0.06	mJ



NCE65R2K2I, NCE65R2K2K

Parameter	Symbol	Value	Unit
Drain Source voltage slope, V _{DS} ≤480 V,	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS} \le 480 \text{ V,I}_{SD} < I_{D}$	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55+150	°C

Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R_{thJC}	5.4	°C W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	75	°C W

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states	•		•	•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	650			V
Zero Gate Voltage Drain Current(Tc=25℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			10	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±30V, V_{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.5	3	3.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =1A		2200	2500	mΩ
Dynamic Characteristics						
Forward Transconductance	g FS	V _{DS} = 20V, I _D = 1A		2		S
Input Capacitance	C _{lss}	\/ -50\/\/ -0\/		190		PF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V, F=1.0MHz		13		PF
Reverse Transfer Capacitance	C _{rss}	F=1.UMHZ		1.1		PF
Total Gate Charge	Q_g	V -400V L -0A		3.2	10	nC
Gate-Source Charge	Q_{gs}	V _{DS} =480V,I _D =2A,		0.6		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V		1.2		nC
Intrinsic gate resistance	R _G	f = 1 MHz open drain		9		Ω
Switching times						
Turn-on Delay Time	t _{d(on)}			6		nS
Turn-on Rise Time	t _r	V_{DD} =380V, I_{D} =1A,		3		nS
Turn-Off Delay Time	$t_{d(off)}$	$R_G=50\Omega, V_{GS}=10V$		65		nS
Turn-Off Fall Time	t _f			11		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T -25°C			2	Α
Pulsed Source-drain current(Body Diode)	I _{SDM}	T _C =25°C			6	Α
Forward On Voltage	V _{SD}	Tj=25°C,I _{SD} =2A,V _{GS} =0V		1	1.3	V
Reverse Recovery Time	t _{rr}			140		nS
Reverse Recovery Charge	Q _{rr}	Tj=25°C,I _F =2A,di/dt=100A/µs		0.65		uC
Peak reverse recovery current	I _{rrm}			9		Α

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

^{2.} Tj=25°C,VDD=50V,VG=10V, R_G=25 Ω





TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

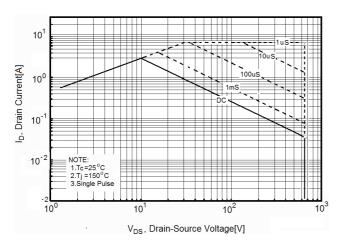


Figure 3. Output characteristics

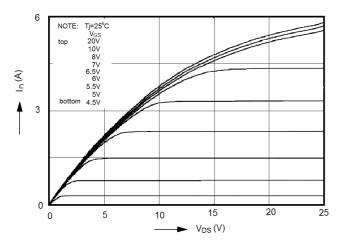


Figure 5. Static drain-source on resistance

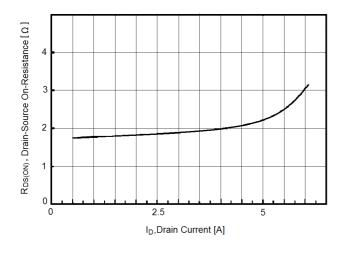


Figure 2. Source-Drain Diode Forward Voltage

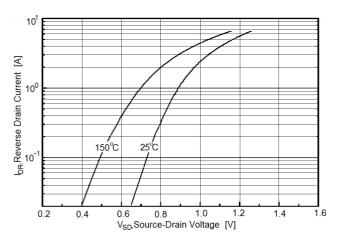


Figure 4. Transfer characteristics

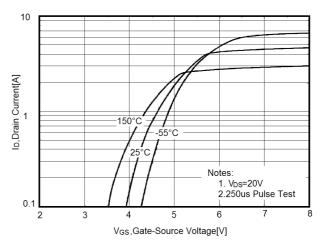


Figure 6. R_{DS(ON)} vs Junction Temperature

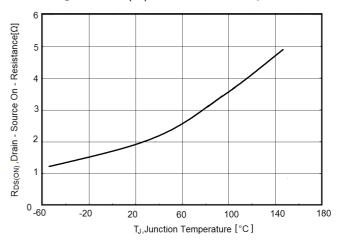






Figure 7. BV_{DSS} vs Junction Temperature

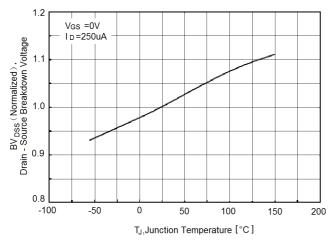


Figure 9. Gate charge waveforms

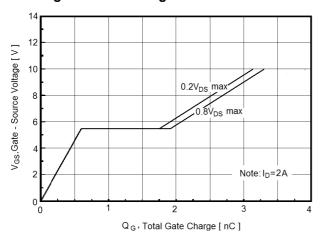


Figure 11. Transient Thermal Impedance

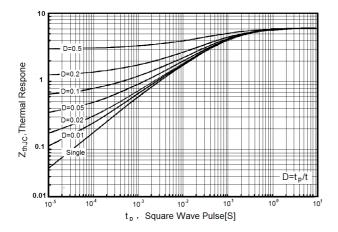


Figure 8. Maximum I_D vs Junction Temperature

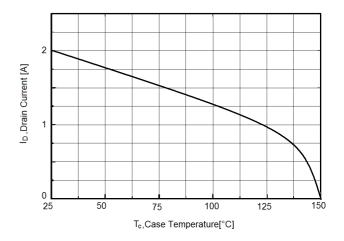
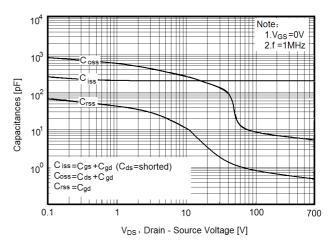
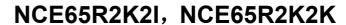


Figure 10. Capacitance

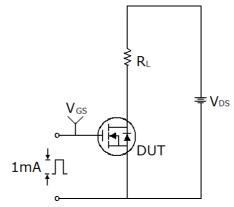


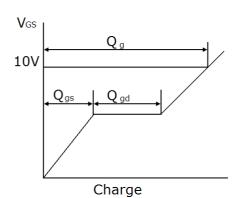




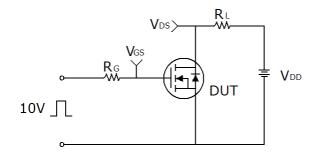
Test circuit

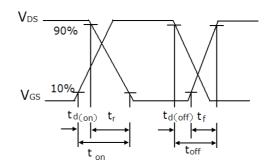
1) Gate charge test circuit & Waveform



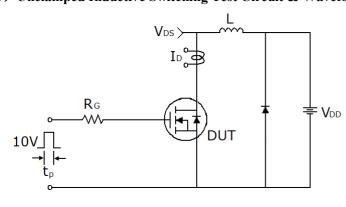


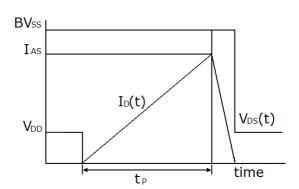
2) Switch Time Test Circuit:





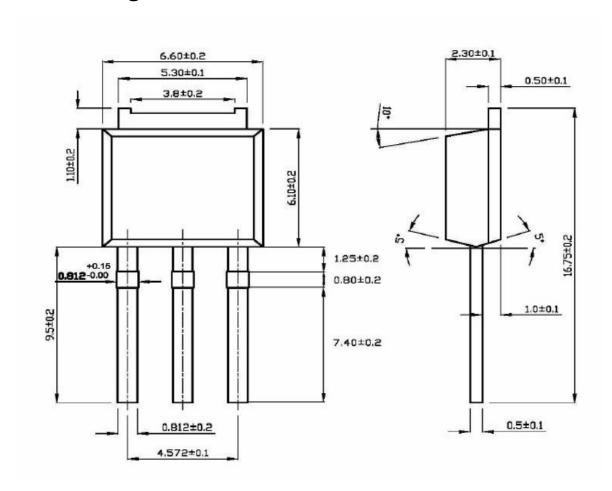
3) Unclamped Inductive Switching Test Circuit & Waveforms

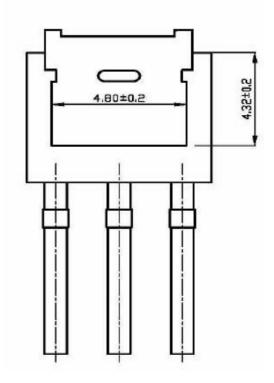






TO-251 Package Information

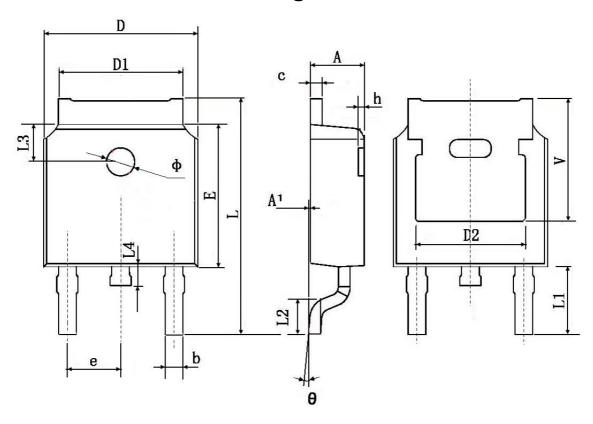




Wuxi NCE Power Semiconductor Co., Ltd



TO-252 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.83	0 TYP.	0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.90	2.900 TYP.		TYP.	
L2	1.400	1.700	0.055	0.067	
L3	1.60	0 TYP.	0.063	TYP.	
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.35	5.350 TYP.		TYP.	

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